*Customer:

SPECIFICATION

ITEM	FLASH LED DEVICE
MODEL	FCW200Z
REVISION DATE	Rev0.5(070727)

[Contents]

- 1. Features
- 2. Absolute maximum ratings
- 3. Electro-optical characteristics
- 4. Soldering profile
- 5. Outline dimension
- 6. Precaution for use

Drawn by	Checked by	Approved by

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1. Features

- $\square~$ Package : 2.3 $\,\times\,$ 1.9 $\,\times\,$ 0.75 mm
- □ Color coordinates: according to CIE 1931
- \Box Tape and reel packing

2. Absolute Maximum Ratings

(Ta=25℃)

Parameter	Symbol	Value	Unit
Power Dissipation	P _d	800	mW
Forward Current	$I_{\rm F}$	250	mA
Peak Forward Current	${\rm I_{FM}}^{*1}$	750	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{opr}	-30 ~ 80	Ĵ
Storage Temperature	T _{stg}	-40 ~ 100	°C

*1 $~~I_{FM}$ conditions: Pulse width Tw \leq 300ms, Duty ratio \leq 1/10

3. Electro-Optical Characteristics

(Ta=25℃)

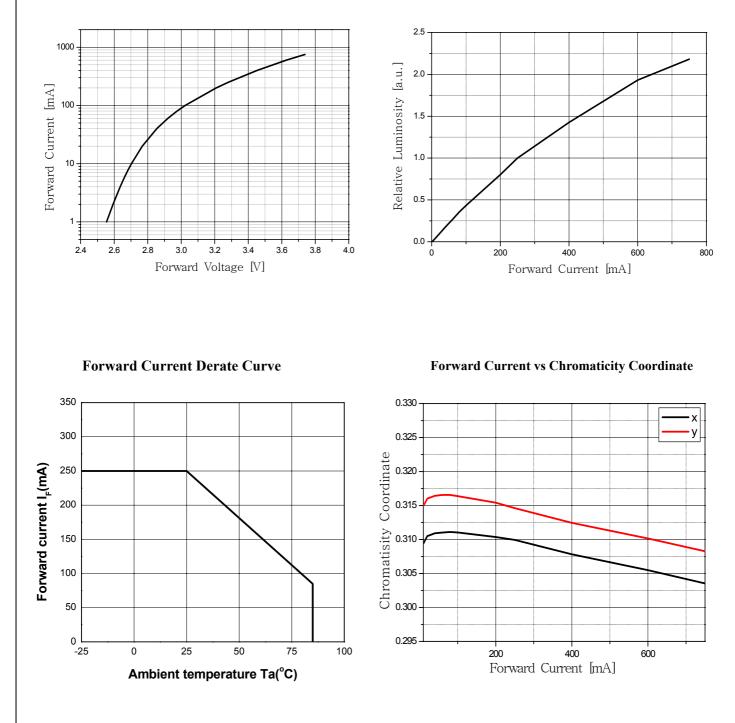
et Electre optical chan	5. Electro-Optical Characteristics					
Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	$V_{\rm F}$	$I_F = 250 \text{ mA}$	-	3.2	-	V
Reverse Current	I _R	V _R =5V	-	-	50	μA
Luminous Intensity *2	I _V	$I_{\rm F}\!\!=\!\!250$ mA	-	14	-	cd
		I_F =400mA (Flash mode) *3	-	20	-	
		$I_F=750$ mA (Peak current mode) ^{*4}	-	30	-	
Illumination	lx	I_F =400mA (Flash mode) *3		41		lx@0.7m
				20		lx@1m
Luminous Flux	lm	$I_F = 250 \text{ mA}$		39.5		lm
Chromaticity Coordinates	Х	$I_F = 250 \text{ mA}$	-	0.31	-	
	Y	$I_F = 250 \text{ mA}$	-	0.32	-	
Viewing Angle	Δ 1/2Θ	$I_F = 250 \text{ mA}$	-	115	-	٥

*2 The luminous intensity I_V is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package. *3 Flash mode condition is Pulse width Tw = 2sec, Duty ratio = 2/7*4 Peak current mode is Pulse width Tw \leq 300ms, Duty ratio \leq 1/10

 $[Note] \ (\ Tolerance: \ IV \ 10\%, \ color \ coordinate \ 0.01, \ V_F \ 0.1 \)$

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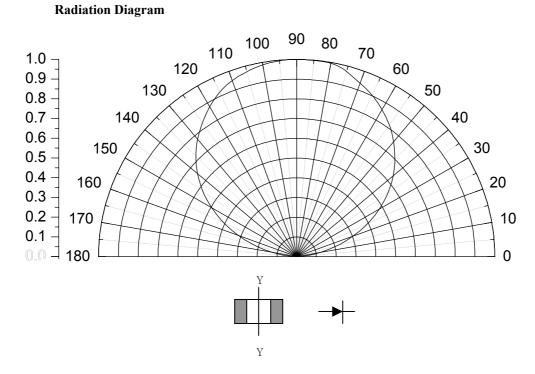


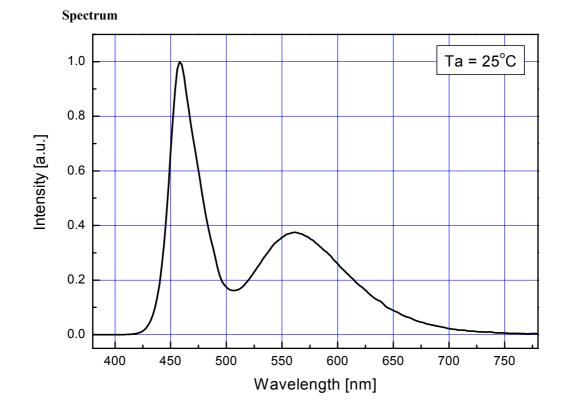
Forward Current vs. Forward Voltage

Luminous Intensity vs. Forward Current

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(Ta=25℃)





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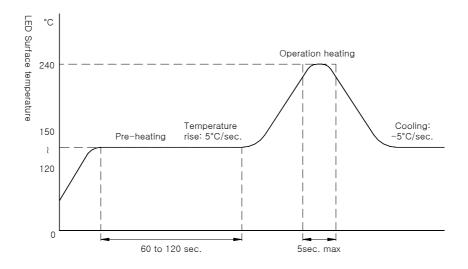
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4. Soldering Profile

Reflow Soldering Conditions/ Profile

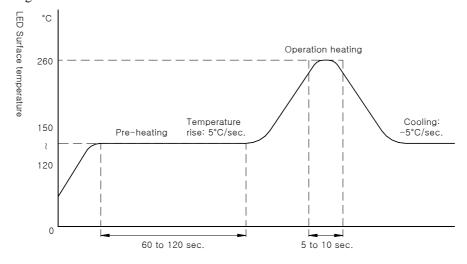
(1) Lead Solder

-Preliminary heating to be at 150 ℃ max. for 2 minutes max. -Soldering heat to be at 240 ℃ max. for 5 seconds max.



(2) Lead-Free Solder

-Preliminary heating to be at 150 ℃ max. for 2 minutes max. -Soldering heat to be at 260 ℃ max. for 10 seconds max.



(3) Hand Soldering conditions

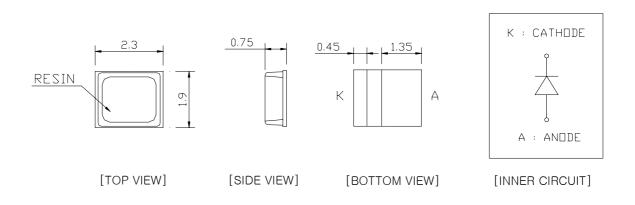
-Not more than 3 seconds @MAX280°C, under Soldering iron.

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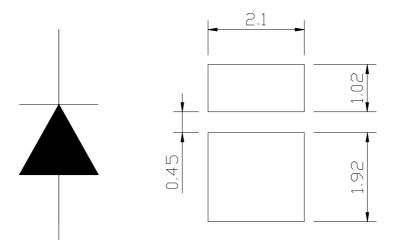
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5. Outline Dimension

Tolerance: ±0.1, Unit: mm



* Recommend solder pad pattern



- Please refer to the *"Thermal Design Guideline for Hi Power Flash LED"* for heat dissipation pattern design.

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6. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desicator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature : $5^{\circ}C \sim 30^{\circ}C$ Humidity : 60%HR max.

(2) Attention after opened

However LED is corresponded SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed.

- a. After opened and mounted, the soldering shall be quickly.b. Keeping of a fractionTemperature : $5 \sim 40 \,^{\circ}{
 m C}$ Humidity : less than 30%
- (3) In case of more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at 60 ± 5 °C.
- (4) In case of supposed the components is humid, shall be dried dip-solder just before. 100Hr at $80\pm5^{\circ}$ or 12Hr at $100\pm5^{\circ}$.
- (5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.
- (6) Quick cooling shall not be avoid.
- (7) Components shall not be mounted on warped direction of PCB.
- (8) Anti radioactive ray design is not considered for the products listed here in.
- (9) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.
- (10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- (12) The LEDs must be soldered within seven days after opening the moisture-proof packing.
- (13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (14) The appearance and specifications of the product may be modified for improvement without notice.
- (15) Static Electricity and surge damages the Blue LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

- All devices, equipment and machinery must be properly grounded.
- (16) It is recommended to use individual resistor separately when the LEDs applies in parallel circuit so that it may improve the light deviations.

<u>SSC-QP-0401-06(REV.0)</u>